

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT4872188

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JARMO SAASKI	03/06/2018
MIKKO HEIKKINEN	03/06/2018
TERO HEIKKINEN	03/06/2018
MIKA PAANI	03/06/2018
JAN TILLONEN	03/13/2018
RONALD HAAG	03/07/2018
RECEIVING PARTY DATA	
Name:	TACTOTEK OY
Street Address:	AUTOMAATIOTIE 1,
City:	OULUNSALO
State/Country:	FINLAND
Postal Code:	90460
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15924697
CORRESPONDENCE DATA	
Fax Number:	(631)501-3526
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	631-501-5700
Email:	docket@cdfslaw.com, kdugo@cdfslaw.com
Correspondent Name:	CARTER, DELUCA, FARRELL & SCHMIDT, LLP
Address Line 1:	445 BROAD HOLLOW ROAD
Address Line 2:	SUITE 420
Address Line 4:	MELVILLE, NEW YORK 11747
ATTORNEY DOCKET NUMBER:	44605-24 P/U
NAME OF SUBMITTER:	ROBERT P. MICHAL
SIGNATURE:	/Robert P. Michal/
DATE SIGNED:	03/19/2018
This document serves as an Oath/Declaration (37 CFR 1.63).	

PATENT

Total Attachments: 6

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DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE

TITLE OF INVENTION:	MULTILAYER STRUCTURE AND RELATED METHOD OF MANUFACTURE FOR ELECTRONICS
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As the below named inventor, I hereby declare that:

This declaration is directed to:

The attached application, or
 United States application or PCT international application number _____ filed on _____.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S. C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

WHEREAS, I, the below-identified Inventor, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and/or patent(s) (hereinafter "Invention");

WHEREAS, TactoTek Oy (hereinafter "Assignee") having place of business at: Automaatiotie 1, 90460 Oulunsalo, Finland, is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States or its territorial possessions and in any and all foreign countries;


NOW, this indenture witnesseth, that in consideration of the sum of ONE DOLLAR (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration:

I hereby assign, sell and transfer my above-identified rights, title and interest in said Invention, said application(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said Invention, and in and to any and all reissues and reexaminations thereof, which may be granted or have granted for said Invention, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto said Assignee;

And I hereby authorize and request the Commissioner of Patents and Trademarks to issue any United States Letters Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;

And I further agree to sign and execute all necessary and lawful further documents, including applications for foreign patents, for filing divisions, continuations, and continuations-in-part of said application for patent and/or for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee or its successors and designees may from time to time require and prepare at its own expense.

The undersigned hereby grants the firm of CARTER, DELUCA, FARRELL & SCHMIDT, LLP, located at 445 Broad Hollow Road, Suite 420, Melville, New York 11747, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

LEGAL NAME OF INVENTOR	Inventor: Jarmo SÄÄSKI	Date: <u>6.3 2018</u>
	Signature: 	

CARTER, DELUCA, FARRELL & SCHMIDT, LLP
 445 BROAD HOLLOW ROAD, SUITE 420
 MELVILLE, NEW YORK 11747

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LEGAL NAME OF INVENTOR	Inventor: Mikko HEIKKINEN	Date: <u>6.3.2018</u>
	Signature: 	

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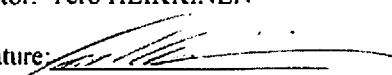
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LEGAL NAME OF INVENTOR	Inventor: Tero HEIKKINEN	Date: <u>6.3.2018</u>
	Signature: 	

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 445 BROAD HOLLOW ROAD, SUITE 420
 MELVILLE, NEW YORK 11747

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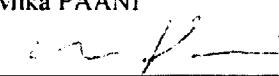
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LEGAL NAME OF INVENTOR	Inventor: Mika PAANI	Date: <u>03.2010</u>
	Signature: 	

CARTER, DELUCA, FARRELL & SCHMIDT, LLP
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LEGAL NAME OF INVENTOR	Inventor: Jan TILLONEN	Date: <u>13.3.2018</u>
	Signature: 	

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 445 BROAD HOLLOW ROAD, SUITE 420
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LEGAL NAME OF INVENTOR	Inventor: Ronald HAAG Signature: <i>Ronald Haag</i>	Date: <u>3/7/2018</u>
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 445 BROAD HOLLOW ROAD, SUITE 420
 MELVILLE, NEW YORK 11747